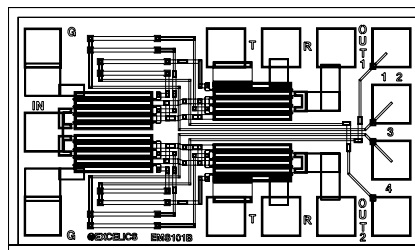


### FEATURES

- BROADBAND PERFORMANCE
- HIGH ISOLATION
- LOW INSERTION LOSS
- LOW DC POWER CONSUMPTION
- FAST SWITCHING SPEED
- Si3N4 PASSIVATION
- ADVANCED EPITAXIAL HETEROJUNCTION PROFILE PROVIDES HIGH RELIABILITY



Caution! ESD sensitive device.

### DESCRIPTION

The EMS101-C is a GaAs IC single pole double throw broadband RF switch chip. It can be used for broadband communications and instrument application. The RF outputs can be terminated with 50ohm load or short circuit. The switch is controlled by 0V/-5V signals to the control lines in accordance with the truth tables below.

### ELECTRICAL CHARACTERISTICS (T<sub>a</sub> = 25 °C)

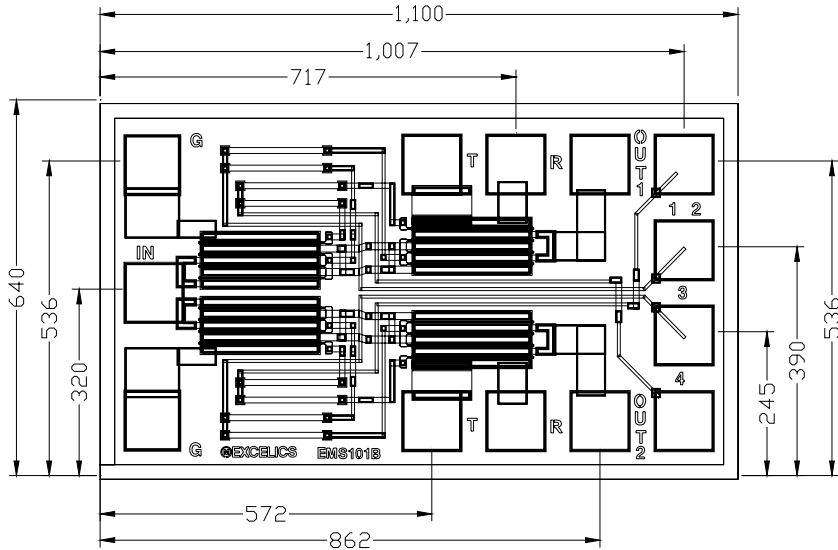
SYMBOL	PARAMETERS/TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>F</b>	Operating frequency Range	DC		6	GHz
<b>P1dB</b>	Input Power at 1dB Gain compression 0/-5V Control; 50MHz 0/-5V Control; 2GHz		17 27		dBm
<b>Ls</b>	Insertion Loss DC-3GHz 3-6GHz		0.9 1.2	1.4 1.8	dB
<b>ISO</b>	Isolation DC-3GHz 3-6GHz	33 30	38 32		dB
<b>RL in</b>	Input Return Loss DC-3GHz 3-6GHz	16 10	19 15		dB
<b>RL out</b>	Output Return Loss DC-3GHz 3-6GHz	18 11	21 16		dB
<b>T</b>	Switching Speed (50% control to 10%/90%RF)		3	8	nS
<b>IP3</b>	Third Order Intercept		46		dBm

Notes:

1. All measurements made in a 50ohm system.
2. P1dB measured input power at which insertion loss compressed by 1 dB.
3. Return Loss measured in low loss switch state

Specifications are subject to change without notice.

### Chip Outline

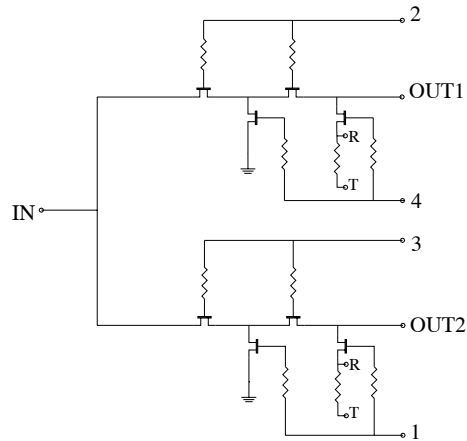


Dimensions indicated in um.  
All bonding pads are 100umx100um.

### Electrical Schematic

### Switching Truth Table

1&2	3&4	IN-OUT1	IN-OUT2
0V	-5V	Low loss	Isolated
-5V	0V	Isolated	Low loss



### Absolute maximum Rating

RF input power                      31dBm  
Operating temperature                -40°C to +85°C  
Storage temperature                  -65°C to 150°C

Ground R: Reflective  
Ground T: Terminated



# EMS101-C

## DC-6GHz GaAs MMIC SPDT SWITCH

### DISCLAIMER

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1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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Specifications are subject to change without notice.

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